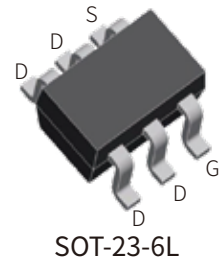


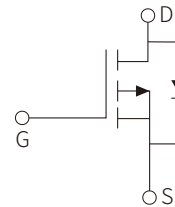
FEATURES

- | $V_{DS} = -60V, I_D = -4A$
- | $R_{DS(ON)} < 104m\Omega @ V_{GS} = -10V$
- | $R_{DS(ON)} < 135m\Omega @ V_{GS} = -4.5V$
- | High density cell design for ultra low Rdson
- | Fully characterized avalanche voltage and current
- | Excellent package for good heat dissipation



APPLICATION

- | Load switch
- | PWM application



Schematic Symbol

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

ABSOLUTE MAXIMUM RATINGS($T_a = 25^\circ C$)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-60	V
Continuous Drain Current	I_D	-4	A
Pulsed Drain Current	I_{DM}	-12	A
Gate Source Voltage	V_{GSS}	± 20	V
Total Power Dissipation	P_D	1.5	W
Junction-to-Ambient Thermal Resistance ^(Note 2)	$R_{\theta JA}$	83.3	$^\circ C/W$
Thermal Resistance, Junction-to-Lead ^(Note 2)	$R_{\theta JL}$	75	$^\circ C/W$
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

ELECTRICAL CHARACTERISTICS (T_A=25°C)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _{DS} =-250μA	-60			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1.1	-1.6	-2.4	V
Drain Cut-Off Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V			-1	μA
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Drain Source ON Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-3A		80	104	mΩ
		V _{GS} =-4.5V, I _D =-2A		104	135	mΩ
Dynamic Characteristics ^(Note4)						
Input capacitance	C _{iss}	V _{GS} =0V, V _{DS} =-30V, f=1.0MHz		980		pF
Output capacitance	C _{oss}			88		pF
Reverse transfer capacitance	C _{rss}			38		pF
Switching Characteristics ^(Note4)						
Total Gate Charge	Q _g	V _{DS} =-30V, V _{GS} =-10V, I _D =-4A		26		nC
Gate-Source Charge	Q _{gs}			3		nC
Gate-Drain Charge	Q _{gd}			8		nC
Turn-on Delay Time	t _{d(on)}	V _{DD} =-30V, V _{GS} =-10V R _L =7.5Ω, R _G =3Ω		8		ns
Turn-on Rise Time	t _r			4		ns
Turn-Off Delay Time	t _{d(off)}			33		ns
Turn-Off Fall Time	t _f			7		ns
Drain-Source Diode Characteristics						
Diode Forward Voltage ^(Note 3)	V _{SD}	I _S =-4A, V _{GS} =0V			-1.2	V
Diode Forward Current ^(Note 2)	I _S				-4	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =- 4A di/dt = -100A/μs ^(Note3)		25		nS
Reverse Recovery Charge	Q _{rr}			31		nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. The value of RθJA is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The value in any given application depends on the user's specific board design. The RθJA is the sum of the thermal impedance from junction to lead RθJL and lead to ambient.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

PARAMETER CHARACTERISTIC CURVE

Figure 1: Output Characteristics

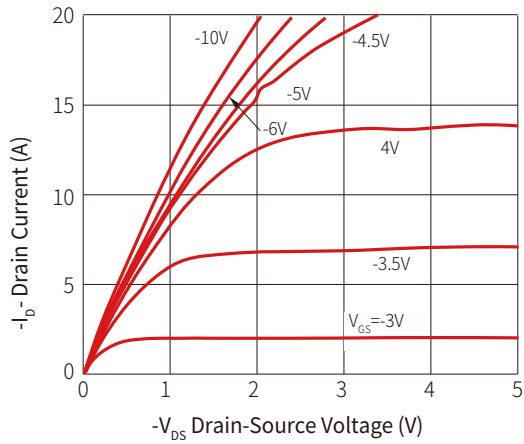


Figure 2: $R_{DS(ON)}$ -Junction Temperature

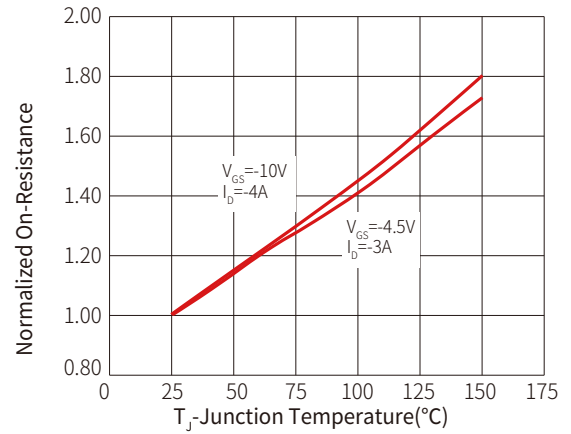


Figure 3: Transfer Characteristics

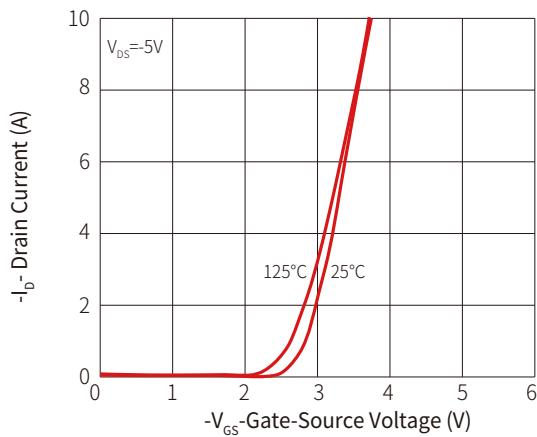


Figure 4: $R_{DS(ON)}$ - Drain Current

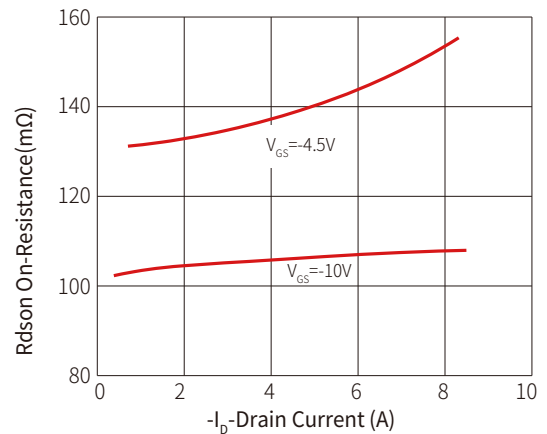


Figure 5: Gate Charge

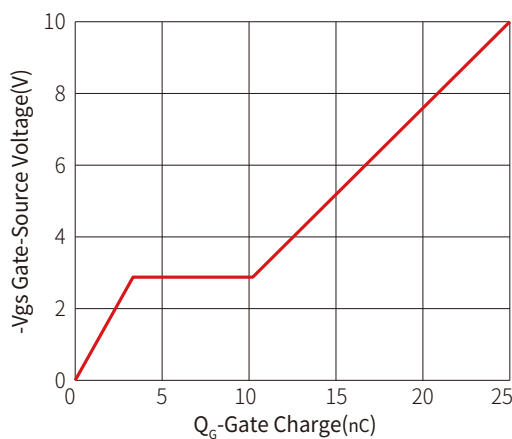


Figure 6: Source-Drain Diode Forward

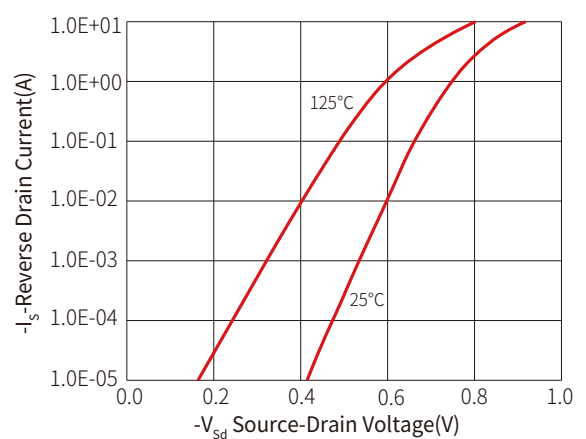
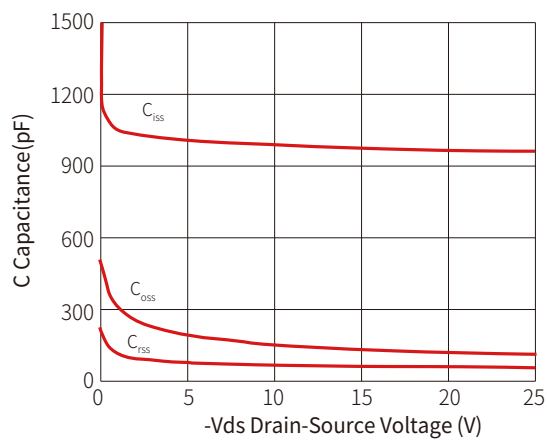
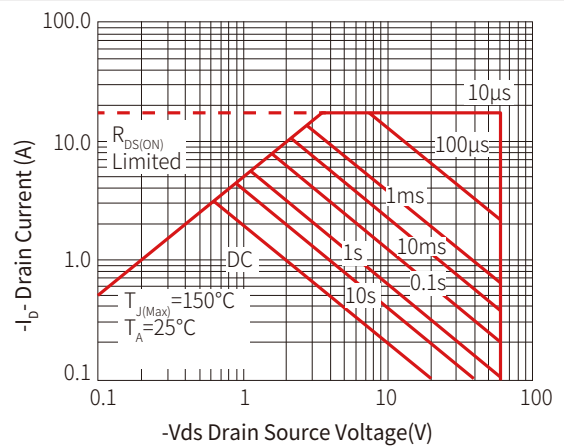
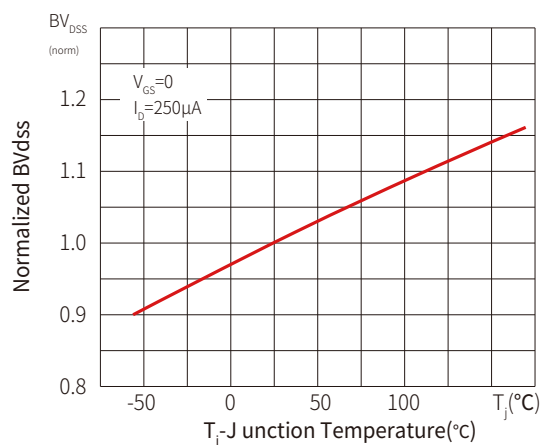
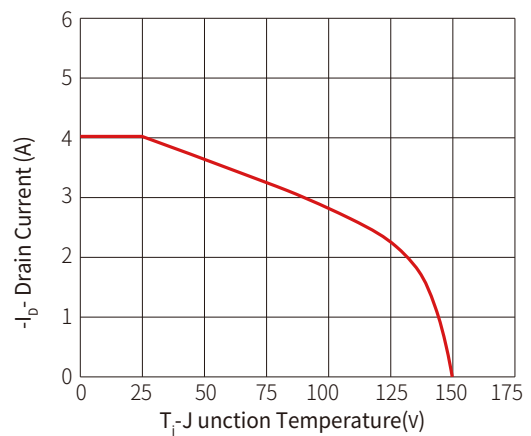
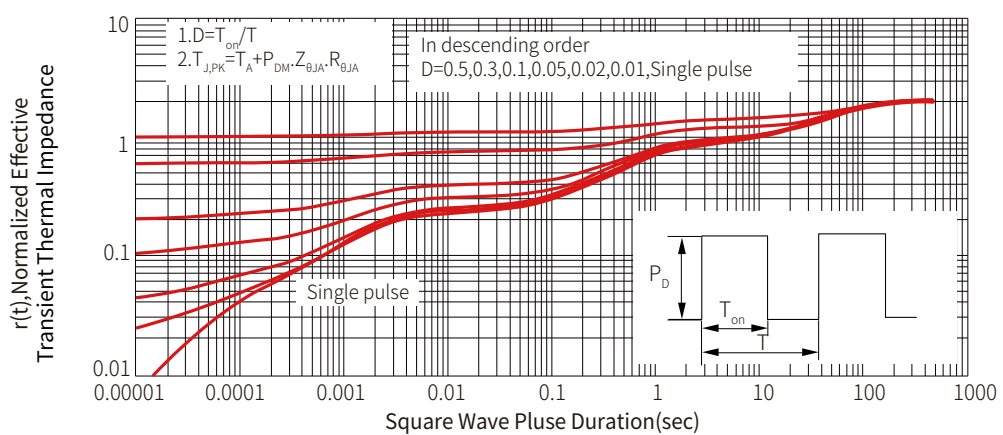
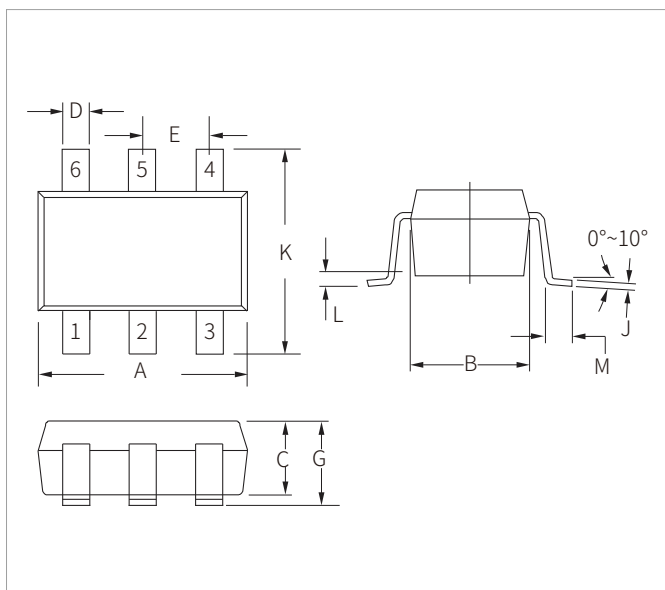


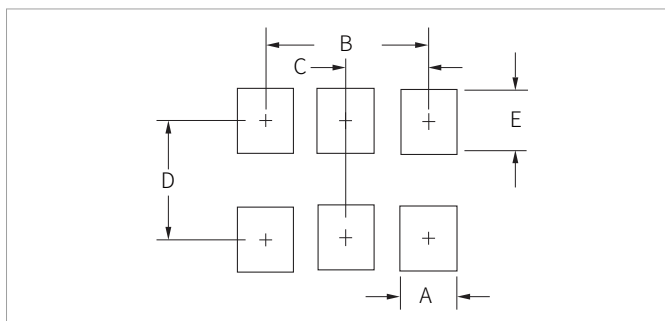
Figure 7: Capacitance vs Vds

Figure 8: Safe Operation Area

Figure 9: BV_{DSS} vs Junction Temperature

Figure 10: Id Current De-rating

Figure 11: Normalized Maximum Transient Thermal Impedance


SOT-23-6L PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.80	3.10	0.110	0.125
B	1.50	1.80	0.059	0.071
C	0.90	1.30	0.036	0.051
D	0.25	0.50	0.010	0.020
E	0.85	1.05	0.033	0.040
G	0.90	1.45	0.036	0.057
J	0.09	0.20	0.003	0.008
K	2.60	3.00	0.102	0.118
L	0.0	0.15	0.0	0.006
M	0.30	0.60	0.012	0.024

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters	Inches
	Nominal	Nominal
A	0.70	0.028
B	1.90	0.074
C	0.95	0.037
D	2.40	0.094
E	1.00	0.039

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SPM06120CS	SOT-23-6L	3000PCS	7"

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